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| PART NUMBER | PRESS-FIT TAIL PLATING TYPE |
| 0028264-101 | TIN/LEAD ALLOY OVER NICKEL |
| 10028264-101LF | TIN OVER NICKEL (LEAD FREE) |

NOTES:

CONNECTOR MATERIALS:

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HOUSING: HIGH TEMP THERMOPLASTIC, NATURAL, UL94V-0 IMLA PLASTIC: HIGH TEMP THERMOPLASTIC, BLACK, UL94V-0 CONTACT: COPPER ALLOY

- 2. CONTACT PLATING:
 - SEPARABLE INTERFACE: PERFORMANCE-BASED PLATING, QUALIFIED TO MEET THE REQUIREMENTS OF FCI PRODUCT SPECIFICATION GS-12-239, INCLUDING TELCORDIA GR-1217-CORE (NOVEMBER 1995) CENTRAL OFFICE. PRESS-FIT TAILS: SEE TABLE

2

- 3. PRODUCT SPECIFICATION: GS-12-239
- 4. APPLICATION SPECIFICATION: GS-20-035
- 5.) PRODUCT MARKING, (PART NUMBER & LOT CODE), ON THIS SURFACE
- (6.) REFER TO CUSTOMER DRAWING 10035911 FOR INFORMATION REGARDING PCB LAYOUT OF POWER AND GUIDE MODULES RELATIVE TO SIGNAL MODULES
- (7.) POSITION F OF ODD NUMBERED COLUMNS AND POSITION G OF EVEN NUMBERED COLUMNS CORRESPOND TO EARLY MATE HEADER PINS
- 8. THERE IS NO GROUND BUSSING WITHIN THE CONNECTOR SYSTEM
- (9.) SEE CUSTOMER DRAWING 10045979 FOR INFORMATION ON PCB HOLE DIAMTER AND PLATING OPTIONS
- IO. THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008

2

II. THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 40 SECONDS IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW OVEN

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12. PACKAGING MEETS GS-14-920 LEAD FREE LABELING SPECIFICATION



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FCI / Amphenol: 10028264-101LF